

02-22-2002

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Form PTO-1595 (Rev. 03/01)	RI	U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office
OMB No. 0651-0027 (exp. 5		000701
To the Honorable Co	mmissioner of Patents and Trademarks	989701: Please record the attached original documents or copy thereof
Name of conveying		Name and address of receiving party(ies)
Yoshiyasu Kubota and Katsuyuki Nakamura		Name: Sony Corporation
		Internal Address:
		Street Address:
Additional name(s) of conveying party(ies) Additional name(s) of conveying party(ies) Yes X No		L 7-35. Kitashinagawa 6-Chome
3. Nature of Convey	ance:	Shinagawa-ku
Assignment	Merger	
Security Agreem	nent Change of Name	City: Tokyo
x Other Correct	ed. Reel/Frame - 012195/0116	State: Japan Zip:
Execution Date: _	September 7, 2001	Additional name(s) & Yes X No address(es) attached:
4. Application numb	per(s) or patent number(s):	
If this document is being A. Patent Application 09/862,549	g filed together with a new application, the ϵ on No.(s):	B. Patent No.(s):
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Name and address of party to whom correspondence concerning document should be mailed:		Total number of applications and patents involved: 1 1 1 1 1 1 1 1 1 1 1 1 1
Name: Robert B. Co LERNER, DA MENTLIK, LL	AVID, LITTENBERG, KRUMHOLZ &	7. Total fee (37 CFR 3.41) \$ 40.00
Internal Address:		Enclosed
Street Address: 600 South Avenue West		x Authorized to be charged to deposit account
		8. Deposit account number:
Oib	State: Zip:	12-1095
City: Westfield	State: Zip: NJ 07090	(Attach duplicate copy of this page if paying by deposit account)
	DO NOT USE	THIS SPACE
9. Statement and sign	ature.	
To the best of my kn is a true copy of the		formation is true and correct and any attached copy
Robert B. Co		January 8, 2002 Date
	umber of pages including cover sheet, atta	
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Form **PTO-1595** (Rev. 03/01)

U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office

OMB No. 0651-0027 (exp. 5/31/2002)	
To the Honorable Commissioner of Patents and Trademarks: P 1. Name of conveying party(ies): Yoshiyasu Kubota and Katsuyuki Nakamura Additional name(s) of conveying party(ies) attached? 3. Nature of Conveyance: X Assignment Merger Security Agreement Change of Name	lease record the attached original documents or copy thereof 2. Name and address of receiving party(ies) Name: Sony Corporation Internal Address: Street Address: 7-35, Kitashinagawa 6-ChorneEP 2 4 City: Tokyo
Other	State: Japan Zip:
Execution Date: September 7, 2001	Additional name(s) & Yes X No address(es) attached:
If this document is being filed together with a new application, the exe A. Patent Application No.(s): 09/862,549	B. Patent No.(s):
Additional numbers attache	ed? Yes X No
Name and address of party to whom correspondence concerning document should be mailed: Name: Robert B. Cohen	6. Total number of applications and patents involved:1
LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 3.41) \$ 40.00
Internal Address:	Enclosed
Street Address: 600 South Avenue West City: State: Zip:	Authorized to be charged to deposit account Deposit account number: 12-1095 (Attach duplicate copy of this page if paying by deposit account)
Westfield NJ 07090 DO NOT USE 1	
9. Statement and signature. To the best of my knowledge and belief, the foregoing infois a true copy of the original document. Robert B. Cohen	September 21, 2001 Date

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Docket Number: SONYJP 3.0-172 Sony Ref. No.: S01P0797US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

ELECTRONIC DEVICE, UNIT USING THE SAME, AND SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 09/862,549, Filing Date: May 22, 2001.

This assignment executed on the dates indicated below.

Yoshiyasu Kubota	
Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Kanagawa, Japan	
Residence of First or Sole Inventor Yoshiyası dubota	Sep 7, 200/
Signature of First or Sole Inventor	Date of this Assignment

PATENT REEL: 012585 FRAME: 0118

Docket Number: SONYJP 3.0-172

Katsuyuki Nakamura	
Name of Second Joint Inventor	Execution Date of U.S. Patent Application
Kanagawa, Japan	
Residence of Second Joint Inventor	•
Katsuyuki hakamura	Sep 7 2001
Signature of Second Joint Inventor	Date of this Assignment
Name of Third Joint Inventor	Execution Date of U.S. Patent Application
Residence of Third Joint Inventor	
Signature of Third Joint Inventor	Date of this Assignment
Name of Fourth Joint Inventor	Execution Date of U.S. Patent Application
Residence of Fourth Joint Inventor	
Signature of Fourth Joint Inventor	Date of this Assignment
Name of Fifth Joint Inventor	Execution Date of U.S. Patent Application
Residence of Fifth Joint Inventor	
Signature of Fifth Joint Inventor	Date of this Assignment

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PATENT REEL: 012585 FRAME: 0119